

# ICMEP | The 11th International Conference on Manufacturing Engineering and Processes

Seoul, South Korea | June 6-8, 2022

[www.icmep.org](http://www.icmep.org)

## Call for Papers

### Publication



Accepted and registered papers will be published in **Lecture Notes in Mechanical Engineering** as a proceedings book volume. Springer will conduct quality checks on the accepted papers and only papers that pass these checks will be published. Indexed by **Scopus**, The volume will be submitted for indexing to **Web of Science**.



### Publication History

ICMEP 2021 - Lecture Notes in Mechanical Engineering with eBook ISBN: 978-981-16-3934-0 - Indexed by SCOPUS  
ICMEP 2020 - E3S proceedings-Volume 162 (2020)  
ICMEP 2019 - E3S proceedings with eISBN 2267-1242 vol. 95 - Indexed by EI Compendex, SCOPUS  
ICMEP 2018 - Solid State Phenomena Vol. 278 - Indexed by EI Compendex, SCOPUS  
ICMEP 2017 - IOP Conference Series: Journal of Physics: Conference Series Vol. 885 - Indexed by EI Compendex, SCOPUS  
ICMEP 2016 - Materials Science Forum Vol. 887 - Indexed by EI Compendex, SCOPUS  
ICMEP 2015 - Applied Mechanics and Materials Vol. 789-790 Part I and Part II  
ICMEP 2014 - Applied Mechanics and Materials Vol. 540-549 - Indexed by EI Compendex, SCOPUS  
ICMEP 2013 - Applied Mechanics and Materials Vol. 325-326 - Indexed by EI Compendex  
ICMEP 2012 - Applied Mechanics and Materials Vol. 505 - Indexed by EI Compendex

### Topics

Casting and solidification  
Coatings and surface engineering  
Modeling, analysis, and simulation of manufacturing processes  
Nanofabrication, nanometrology and applications  
Nanomaterials and nanomanufacturing  
Nontraditional manufacturing  
To get more details, please go to: <http://www.icmep.org/cfp.html>

### Submission Method

**Online Submission System:** <http://confsys.iconf.org/submission/icmep2022>  
**Email Submission:** [icmep@cbees.net](mailto:icmep@cbees.net)

### Keynote Speaker



**Prof. Ramesh K. Agarwal (Fellow of IEEE, AIAA, AAAS, APS, ASME)**  
Washington University in St. Louis, USA



**Prof. Osamu Tabata (Fellow of IEEE, IEEJ)**  
Kyoto University of Advanced Science, Japan



**Dr. Eui Lee**  
Loyola Marymount University, USA



**Prof. Yong Suk Yang**  
Pusan National University, Korea

### Conference Chairs

Prof. Ramesh K. Agarwal, Washington University in St. Louis, USA  
Prof. Omar S. Es-Said, Loyola Marymount University, USA

### Program Chairs

Assoc. Prof. Ken Mao, Warwick University, UK  
Prof. Rong Liu, Carleton University, Canada

### Student Program Chair

Prof. Yong Suk Yang, Pusan National University, Korea

### Important Dates

Submission Deadline	March 10, 2022
Notification Due	March 30, 2022
Registration Deadline	April 10, 2022
Conference	June 6-8, 2022

### Contact

Conference Secretariat: Ms. Jane Li      Email: [icmep@cbees.net](mailto:icmep@cbees.net)  
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